IR2101 IR2102

#### HIGH AND LOW SIDE DRIVER

#### **Features**

• Floating channel designed for bootstrap operation

Fully operational to +600V Tolerant to negative transient voltage dV/dt immune

- Gate drive supply range from 10 to 20V
- Undervoltage lockout
- 5V Schmitt-triggered input logic
- Matched propagation delay for both channels
- Outputs in phase with inputs (IR2101) or out of phase with inputs (IR2102)

#### **Description**

The IR2101/IR2102 are high voltage, high speed power MOSFET and IGBT drivers with independent high and low side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output. The output drivers feature a high

#### **Product Summary**

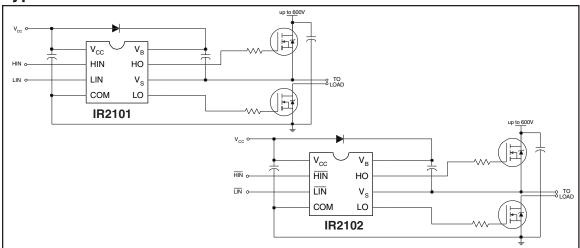
Voffset	600V max.
I <sub>O</sub> +/-	130 mA / 270 mA
Vout	10 - 20V
t <sub>on/off</sub> (typ.)	160 & 150 ns
Delay Matching	50 ns

#### **Packages**



pulse current buffer stage designed for minimum driver cross-conduction. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high side configuration which operates up to 600 volts.

#### **Typical Connection**



#### **Absolute Maximum Ratings**

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition		Min.	Max.	Units
V <sub>B</sub>	High side floating supply voltage		-0.3	625	
Vs	High side floating supply offset voltage		V <sub>B</sub> - 25	V <sub>B</sub> + 0.3	
V <sub>HO</sub>	High side floating output voltage		V <sub>S</sub> - 0.3	V <sub>B</sub> + 0.3	V
V <sub>CC</sub>	Low side and logic fixed supply voltage		-0.3	25	, v
V <sub>LO</sub>	Low side output voltage		-0.3	V <sub>CC</sub> + 0.3	
V <sub>IN</sub>	Logic input voltage (HIN & LIN)		-0.3	V <sub>CC</sub> + 0.3	
dV <sub>S</sub> /dt	Allowable offset supply voltage transient		_	50	V/ns
PD	Package power dissipation @ T <sub>A</sub> ≤ +25°C	(8 lead PDIP)	_	1.0	144
		(8 lead SOIC)	_	0.625	W
RthJA	Thermal resistance, junction to ambient	(8 lead PDIP)	_	125	°C/W
		(8 lead SOIC)	_	200	C/VV
TJ	Junction temperature		_	150	
T <sub>S</sub>	Storage temperature		-55	150	°C
TL	Lead temperature (soldering, 10 seconds)		_	300	

#### **Recommended Operating Conditions**

The input/output logic timing diagram is shown in figure 1. For proper operation the device should be used within the recommended conditions. The  $V_S$  offset rating is tested with all supplies biased at 15V differential.

Symbol	Definition	Min.	Max.	Units
V <sub>B</sub>	High side floating supply absolute voltage	V <sub>S</sub> + 10	V <sub>S</sub> + 20	
Vs	High side floating supply offset voltage	Note 1	600	
V <sub>HO</sub>	High side floating output voltage	VS	V <sub>B</sub>	v
V <sub>CC</sub>	Low side and logic fixed supply voltage	10	20	
V <sub>LO</sub>	Low side output voltage	0	Vcc	
V <sub>IN</sub>	Logic input voltage (HIN & LIN) (IR2101) & (HIN & LIN) (IR2102)	0	V <sub>CC</sub>	
T <sub>A</sub>	Ambient temperature	-40	125	°C

Note 1: Logic operational for V<sub>S</sub> of -5 to +600V. Logic state held for V<sub>S</sub> of -5V to -V<sub>BS</sub>.

#### **Dynamic Electrical Characteristics**

 $V_{BIAS}$  ( $V_{CC}$ ,  $V_{BS}$ ) = 15V,  $C_L$  = 1000 pF and  $T_A$  = 25°C unless otherwise specified.

Symbol	Definition	Min.	Тур.	Max.	Units	<b>Test Conditions</b>
ton	Turn-on propagation delay	_	160	220		V <sub>S</sub> = 0V
toff	Turn-off propagation delay	_	150	220		V <sub>S</sub> = 600V
t <sub>r</sub>	Turn-on rise time	_	100	170	ns	
tf	Turn-off fall time	_	50	90		
MT	Delay matching, HS & LS turn-on/off		_	50		

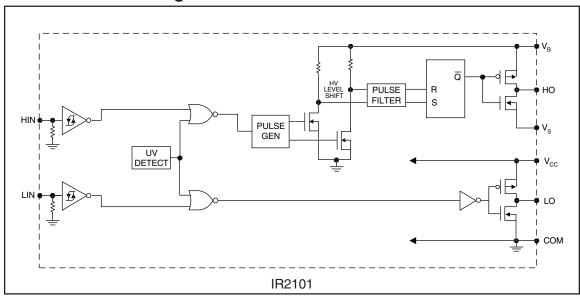
#### **Static Electrical Characteristics**

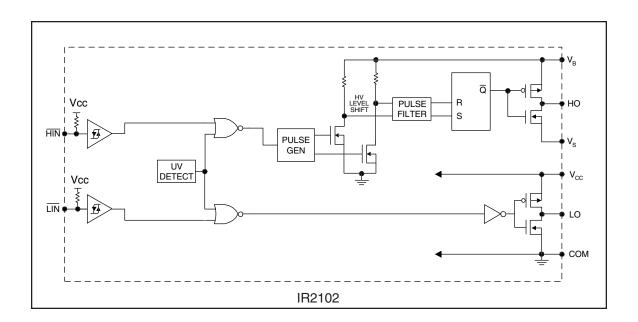
 $V_{BIAS}$  ( $V_{CC}$ ,  $V_{BS}$ ) = 15V and  $T_A$  = 25°C unless otherwise specified. The  $V_{IN}$ ,  $V_{TH}$  and  $I_{IN}$  parameters are referenced to COM. The  $V_O$  and  $I_O$  parameters are referenced to COM and are applicable to the respective output leads: HO or LO.

Symbol	Definition	Min.	Тур.	Max.	Units	<b>Test Conditions</b>	
V <sub>IH</sub>	Logic "1" input voltage (IR2101)	3	0			V = 10V/to 20V	
	Logic "0" input voltage (IR2102)	3	_	_	V	V <sub>CC</sub> = 10V to 20V	
$V_{IL}$	Logic "0" input voltage (IR2101)			0.8	<b>V</b>	V <sub>CC</sub> = 10V to 20V	
	Logic "1"input voltage (IR2102)			0.0		V(() = 10 V to 20 V	
V <sub>OH</sub>	High level output voltage, $V_{BIAS}$ - $V_{O}$		_	100	mV	$I_O = 0A$	
V <sub>OL</sub>	Low level output voltage, VO		_	100	1110	$I_O = 0A$	
I <sub>LK</sub>	Offset supply leakage current	_	_	50		$V_{B} = V_{S} = 600V$	
I <sub>QBS</sub>	Quiescent V <sub>BS</sub> supply current	_	30	55		V <sub>IN</sub> = 0V or 5V	
IQCC	Quiescent V <sub>CC</sub> supply current		150	270		V <sub>IN</sub> = 0V or 5V	
I <sub>IN+</sub>	Logic "1" input bias current		3	10	μΑ	V <sub>IN</sub> = 5V (IR2101)	
						$V_{IN} = 0V$ (IR2102)	
I <sub>IN-</sub>	Logic "0" input bias current			_ 1		$V_{IN} = 0V$ (IR2101)	
			_			$V_{IN} = 5V$ (IR2102)	
V <sub>CCUV+</sub>	V <sub>CC</sub> supply undervoltage positive going threshold	8	8.9	9.8			
V <sub>CCUV-</sub>	V <sub>CC</sub> supply undervoltage negative going	7.4	8.2	9	V		
1000	threshold						
I <sub>O+</sub>	Output high short circuit pulsed current	130	210	_		V <sub>O</sub> = 0V	
					mA	V <sub>IN</sub> = Logic "1"	
						PW ≤ 10 µs	
I <sub>O-</sub>	Output low short circuit pulsed current	270	360	_		V <sub>O</sub> = 15V	
						V <sub>IN</sub> = Logic "0"	
						PW ≤ 10 μs	

### IR2101/IR2102

### **Functional Block Diagram**

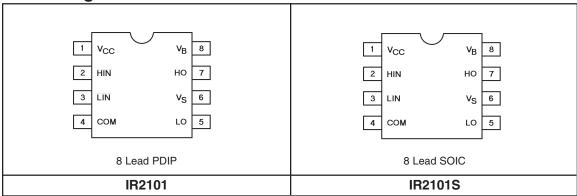


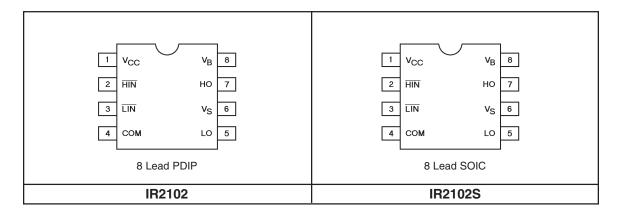


#### **Lead Definitions**

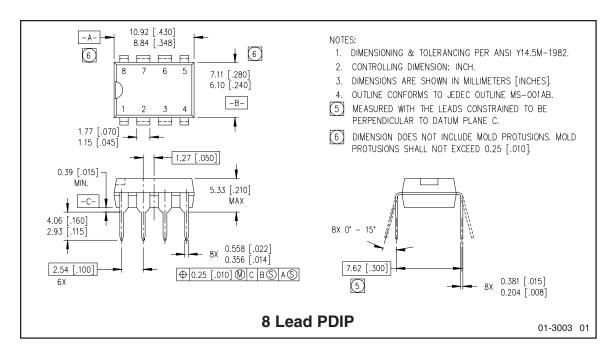
Symbol	Description
HIN	Logic input for high side gate driver output (HO), in phase (IR2101)
HIN	Logic input for high side gate driver output (HO), out of phase (IR2102)
LIN	Logic input for low side gate driver output (LO), in phase (IR2101)
LIN	Logic input for low side gate driver output (LO), out of phase (IR2102)
VB	High side floating supply
НО	High side gate drive output
Vs	High side floating supply return
V <sub>C</sub> C	Low side and logic fixed supply
LO	Low side gate drive output
COM	Low side return

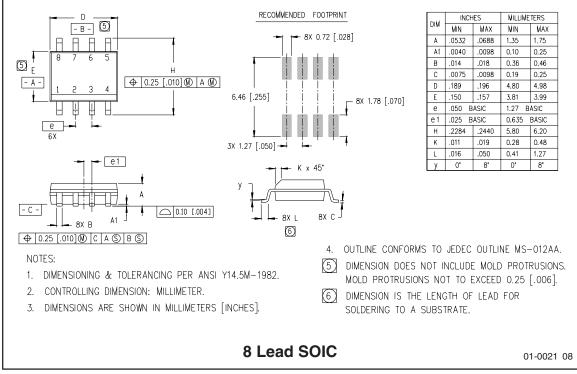
Lead Assignments IR2101



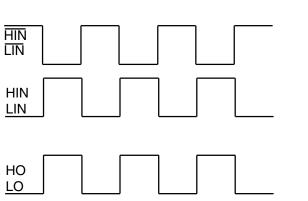


## International TOR Rectifier





### IR2101/IR2102



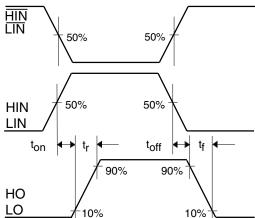


Figure 1. Input/Output Timing Diagram

Figure 2. Switching Time Waveform Definitions

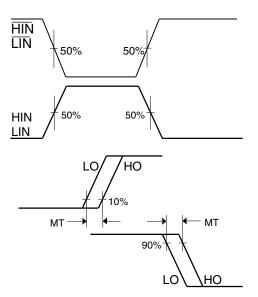


Figure 3. Delay Matching Waveform Definitions

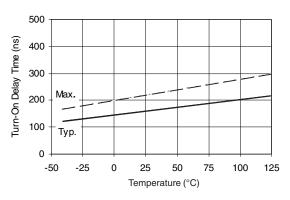


Figure 6A. Turn-On Time vs Temperature

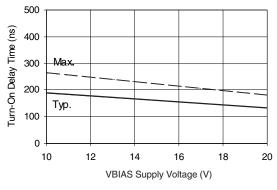


Figure 6B. Turn-On Time vs Voltage

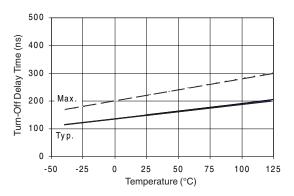


Figure 7A. Turn-Off Time vs Temperature

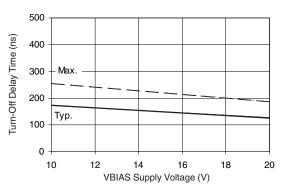


Figure 7B. Turn-Off Time vs Voltage

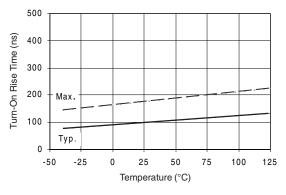


Figure 9A. Turn-On Rise Time vs Temperature

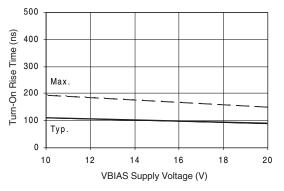


Figure 9B. Turn-On Rise Time vs Voltage

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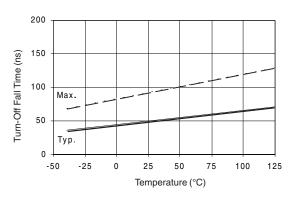


Figure 10A. Turn-Off Fall Time vs Temperature

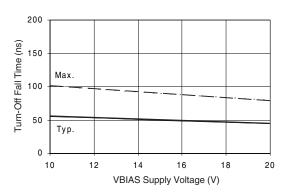


Figure 10B. Turn-Off Fall Time vs Voltage

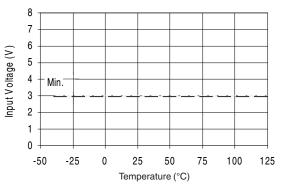


Figure 12A. Logic "1" Input Voltage (IR2101) Logic "0" Input Voltage (IR2102) vs Temperature

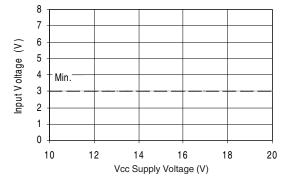


Figure 12B. Logic "1" Input Voltage (IR2101) Logic "0" Input Voltage (IR2102) vs Voltage

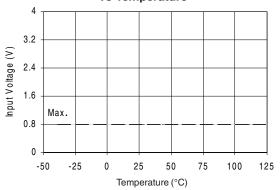


Figure 13A. Logic "0" Input Voltage (IR2101) Logic "1" Input Voltage (IR2102) vs Temperature

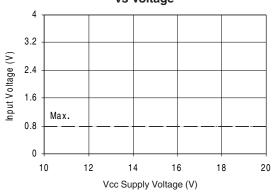


Figure 13B. Logic "0" Input Voltage (IR2101) Logic "1" Input Voltage (IR2102) vs Voltage

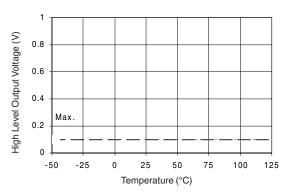


Figure 14A. High Level Output vs Temperature

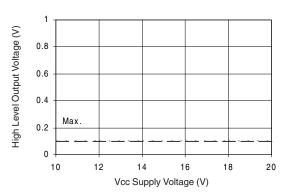


Figure 14B. High Level Output vs Voltage

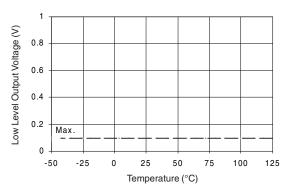


Figure 15A. Low Level Output vs Temperature

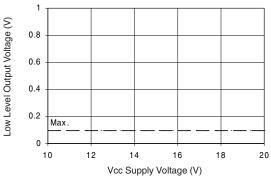


Figure 15B. Low level Output vs Voltage

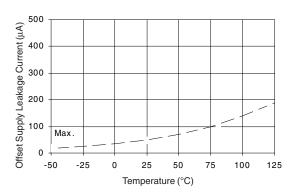


Figure 16A. Offset Supply Current vs Temperature

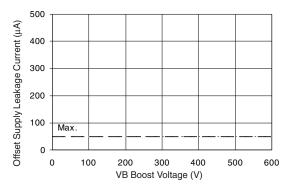


Figure 16B. Offset Supply Current vs Voltage

## International TOR Rectifier

### IR2101/IR2102

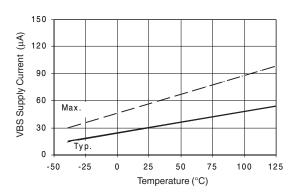


Figure 17A. VBS Supply Current vs Temperature

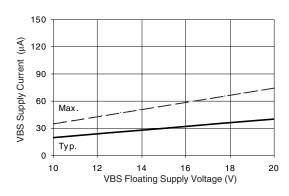


Figure 17B. VBS Supply Current vs Voltage

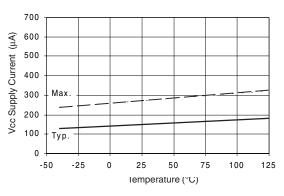


Figure 18A. Vcc Supply Current vs Temperature

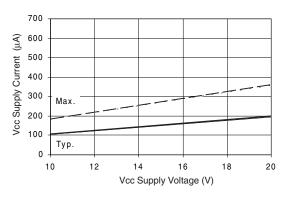


Figure 18B. Vcc Supply Current vs Voltage

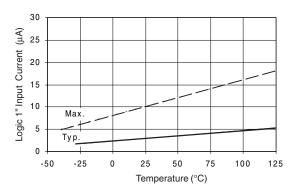


Figure 19A. Logic"1" Input Current vs Temperature

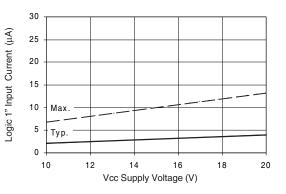


Figure 19B. Logic"1" Input Current vs Voltage

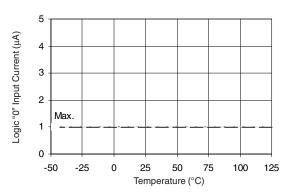


Figure 20A. Logic "0" Input Current vs Temperature

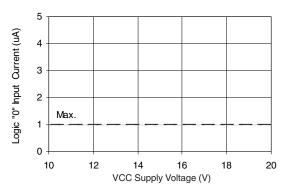


Figure 20B. Logic "0" Input Current vs Voltage

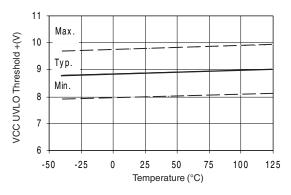


Figure 21A. Vcc Undervoltage Threshold(+) vs Temperature

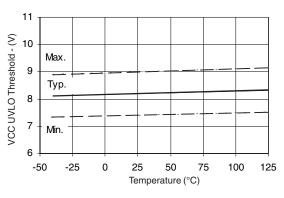


Figure 21B. Vcc Undervoltage Threshold(-) vs Temperature

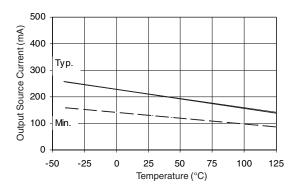


Figure 22A. Output Source Current vs Temperature

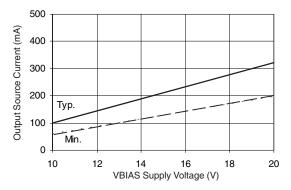


Figure 22B. Output Source Current vs Voltage

## International Rectifier

#### IR2101/IR2102

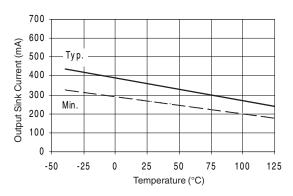


Figure 23A. Output Sink Current vs Temperature

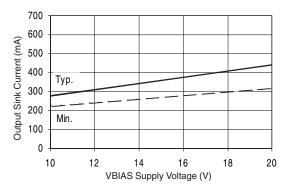


Figure 23B. Output Sink Current vs Voltage

# International TOR Rectifier

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Data and specifications subject to change without notice. 3/29/2000